

# HD74LS273 (with Clear) ●Octal D-type Positive-edge-triggered Flip-Flops

The HD74LS273, positive-edge-triggered flip-flops utilize LS TTL circuitry to implement D-type flip-flop logic with a direct clear input.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse.

Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse.

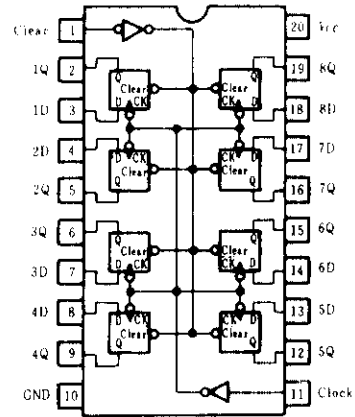
When the clock input is at either the high or low level, the D input signal has no effect at the output.

## FUNCTION TABLE

Inputs			Output
Clear	Clock	D	Q
L	X	X	L
H	↑	H	H
H	↑	L	L
H	L	X	Q <sub>0</sub>

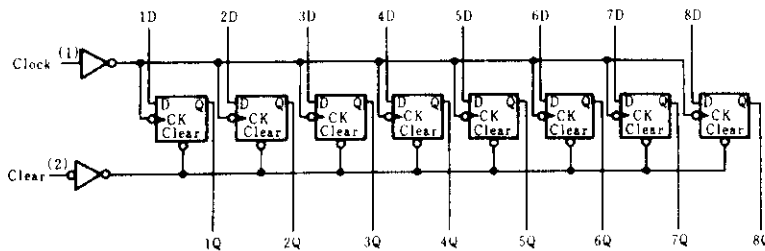
Notes: H = high level, L = low level,  
 X = irrelevant  
 ↑ = transition from low to high level  
 Q<sub>0</sub> = level of Q before the indicated steady-state input conditions were established.

## PIN ARRANGEMENT



(Top View)

## BLOCK DIAGRAM



## RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply voltage	$V_{cc}$	4.75	5.00	5.25	V
Output current	$I_{on}$	—	—	-400	$\mu A$
	$I_{ol}$	—	—	8	mA
Clock frequency	$f_{clock}$	0	—	30	MHz
Clock and clear pulse width	$t_w$	20	—	—	ns
Setup time	Data	20 ↑	—	—	ns
	Clear inactive-state	25 ↑	—	—	
Data hold time	$t_h$	5 ↑	—	—	ns

Note) ↑ : The arrow indicates the rising edge of clock pulse.

## ■ ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim +75^\circ\text{C}$ )

Item	Symbol	Test Conditions	min	typ*	max	Unit
Input voltage	$V_{IH}$		2.0	—	—	V
	$V_{IL}$		—	—	0.8	V
Output voltage	$V_{OH}$	$V_{CC}=4.75\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}, I_{OH}=-400\mu\text{A}$	2.7	—	—	V
	$V_{OL}$	$V_{CC}=4.75\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}$	—	—	0.5	V
Input current	$I_I$	$V_{CC}=5.25\text{V}, V_i=7\text{V}$	—	—	0.1	mA
	$I_{IH}$	$V_{CC}=5.25\text{V}, V_i=2.7\text{V}$	—	—	20	$\mu\text{A}$
	$I_{IL}$	$V_{CC}=5.25\text{V}, V_i=0.4\text{V}$	—	—	-0.4	mA
Short-circuit output current	$I_{OS}$	$V_{CC}=5.25\text{V}$	-20	—	-100	mA
Supply current	$I_{CC}^{**}$	$V_{CC}=5.25\text{V}$	—	17	27	mA
Input clamp voltage	$V_{IK}$	$V_{CC}=4.75\text{V}, I_{IN}=-18\text{mA}$	—	—	-1.5	V

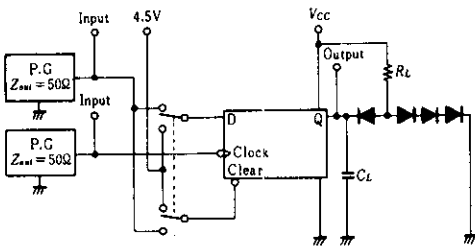
\*  $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$

\*\* : With all outputs open and 4.5V applied to all data and clear inputs,  $I_{CC}$  is measured after a momentary ground, then 4.5V is applied to clock.

## ■ SWITCHING CHARACTERISTICS ( $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$ )

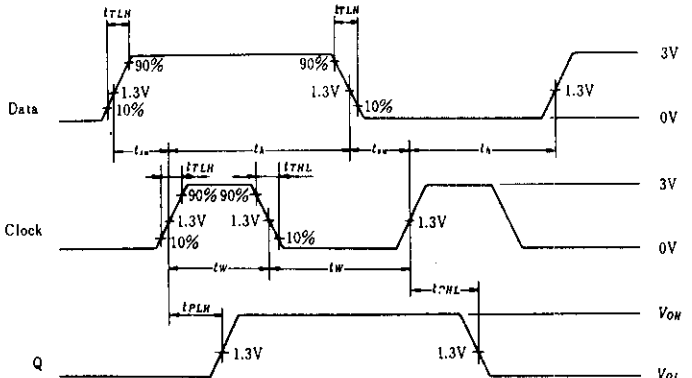
Item	Symbol	Inputs	Test Conditions	min	typ	max	Unit
Maximum clock frequency	$f_{max}$	Clock	$C_L=15\text{pF}, R_L=2\text{k}\Omega$	30	—	—	MHz
Propagation Delay Time	$t_{PHL}$	Clear		—	18	27	ns
	$t_{PLH}$	Clock		—	17	27	
	$t_{PHL}$			—	18	27	

## ■ TESTING METHOD



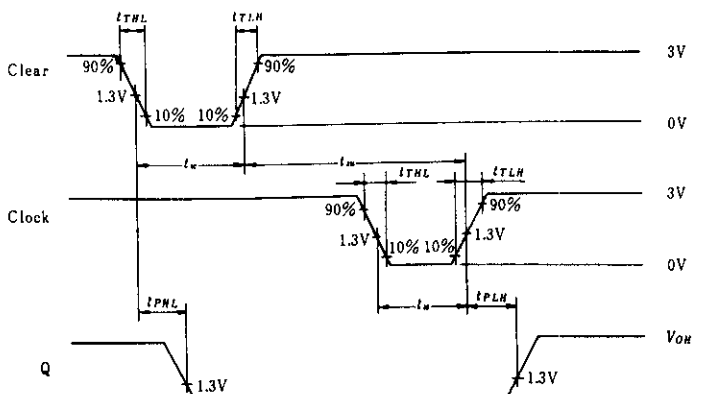
- Notes: 1.  $C_L$  includes probe and jig capacitance.  
2. All diodes are 1S2074  $\oplus$ .

Waveform-1

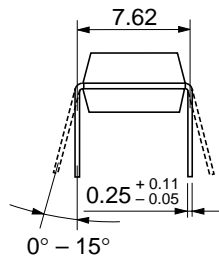
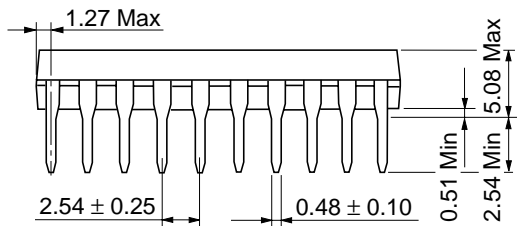
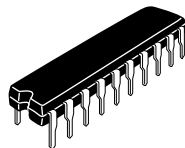
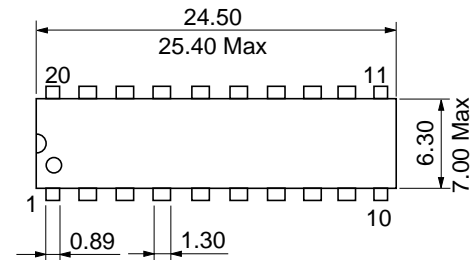


- Notes: 1. Input pulse;  $t_{TLH} \leq 15\text{ns}, t_{TLH} \leq 6\text{ns}$   
Clock input;  $\text{PRR} = 1\text{MHz}$ , duty cycle 50%  
Data input;  $\text{PRR} = 500\text{kHz}$ , duty cycle 50%

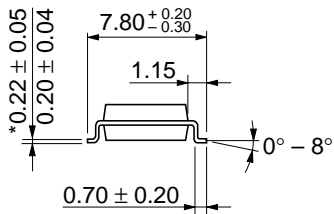
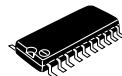
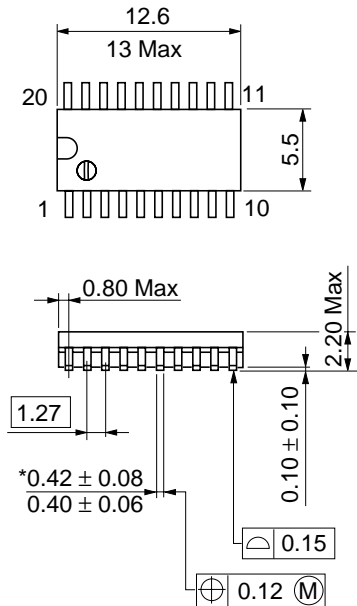
Waveform-2



- Note: Input pulse;  $t_{TLH} \leq 15\text{ns}, t_{TLH} \leq 6\text{ns}, \text{PRR} = 1\text{MHz}$ .

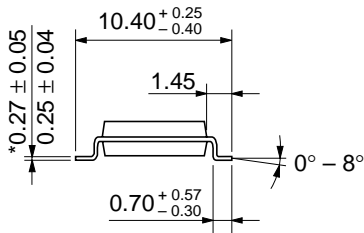
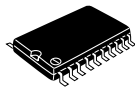
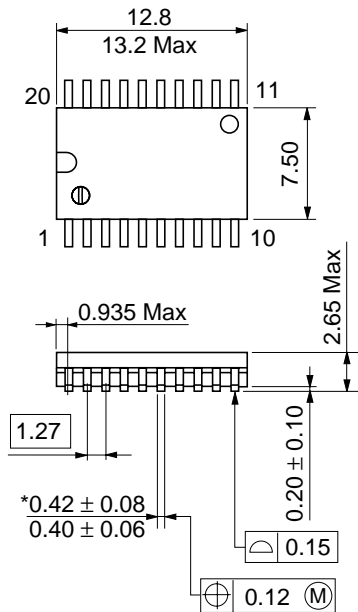


Hitachi Code	DP-20N
JEDEC	—
EIAJ	Conforms
Weight (reference value)	1.26 g



Hitachi Code	FP-20DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.31 g

\*Dimension including the plating thickness  
Base material dimension



Hitachi Code	FP-20DB
JEDEC	Conforms
EIAJ	—
Weight (reference value)	0.52 g

\*Dimension including the plating thickness  
Base material dimension

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# HITACHI

## Hitachi, Ltd.

Semiconductor & Integrated Circuits.  
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan  
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL      North America      : <http://semiconductor.hitachi.com/>  
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## For further information write to:

Hitachi Semiconductor  
(America) Inc.  
179 East Tasman Drive,  
San Jose, CA 95134  
Tel: <1> (408) 433-1990  
Fax: <1>(408) 433-0223

Hitachi Europe GmbH  
Electronic components Group  
Dornacher Straße 3  
D-85622 Feldkirchen, Munich  
Germany  
Tel: <49> (89) 9 9180-0  
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.  
Electronic Components Group.  
Whitebrook Park  
Lower Cookham Road  
Maidenhead  
Berkshire SL6 8YA, United Kingdom  
Tel: <44> (1628) 585000  
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.  
16 Collyer Quay #20-00  
Hitachi Tower  
Singapore 049318  
Tel: 535-2100  
Fax: 535-1533

Hitachi Asia Ltd.  
Taipei Branch Office  
3F, Hung Kuo Building, No.167,  
Tun-Hwa North Road, Taipei (105)  
Tel: <886> (2) 2718-3666  
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.  
Group III (Electronic Components)  
7/F., North Tower, World Finance Centre,  
Harbour City, Canton Road, Tsim Sha Tsui,  
Kowloon, Hong Kong  
Tel: <852> (2) 735 9218  
Fax: <852> (2) 730 0281  
Telex: 40815 HITEC HX

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